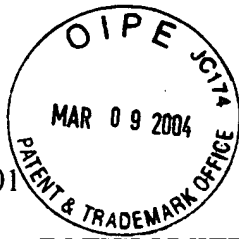


P24637.A01



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Ho soung KIM

Group Art Unit : Unknown

Serial No : 10/724,712

Examiner : Unknown

Filed : December 2, 2003

For : PHASE DEFICIENCY DISPLAY DEVICE FOR THERMAL MAGNETIC
TYPE MOLDED CASE CIRCUIT BREAKER

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

Sir :

In accordance with the duty of disclosure under 37 C.F.R. §1.56 and §§1.97-1.98,
Applicant hereby calls the following co-pending and commonly assigned patent application to
the Examiner's attention:

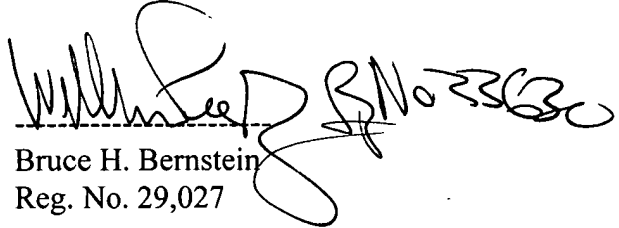
U.S. Patent Application No. 10/694,877 to LEE, entitled "Thermal Overload Relay,"
which was filed on October 29, 2003.

In accordance with 37 C.F.R. §1.98 (a)(2)(iii), a copy of the above-mentioned application
is attached hereto. However, the Examiner is also requested to review the file wrapper of this
U.S. patent application at the U.S. Patent and Trademark Office and the references of record, if
any, cited therein.

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Should the Examiner have any further questions, the Examiner is invited to contact the undersigned at the below-listed telephone number.

Respectfully submitted,
Ho soung KIM



Bruce H. Bernstein
Reg. No. 29,027

February 23, 2004
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